19-0753; Rev 0; 4/07 EVALUATION KIT AVAILABLE



## **General Description**

The MAX2204 RF power detector is designed to operate from 450MHz to 2.5GHz. The device is ideal for wideband code-division multiple access (WCDMA), cdma2000<sup>®</sup>, and high-speed downlink/uplink packet access. The MAX2204 accepts an RF signal at the input, and outputs a highly repeatable voltage. The output voltage increases monotonically with increasing input power. The device is designed to compensate for temperature and process shifts, reducing the typical output variation to less than ±0.5dB at full input power and ±1.5dB at the lower power.

The MAX2204 features a detection range from -16dBm to +5dBm. High input impedance allows for low-loss resistive tap if an isolator is used. The device uses external termination at the input so that the RF signal from several directional couplers can be connected to a single detector chip.

The MAX2204 operates from a 2.7V to 3.3V power supply. The device is available in a tiny 5-pin SC70 package. Electrical performance is guaranteed over a -40°C to +85°C temperature range.

Applications WCDMA, cdma2000 High-Speed Downlink Packet Access (HSDPA) High-Speed Uplink Packet Access (HSUPA)

cdma2000 is a registered trademark of Telecommunications

### Features

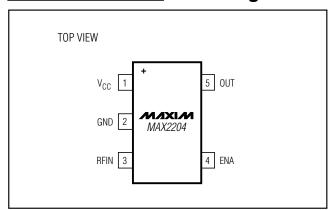
- -16dBm to +5dBm Detection Range
- ±0.3dB Detection Error Due to Temperature
- +2.7V to +3.3V Single-Supply Operation
- Easy-to-Assemble, Lead-Free, 5-Pin SC70 Package

## **Ordering Information**

RANGE PACKAGE	PKG E CODE
o +85°C 5 SC70	X5+1
	PACKAGE

+Denotes a lead-free package.

## Pin Configuration



### 

Industry Association.

\_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

### **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> to GND0.3V to +3.6V
OUT, Logic Input (ENA) to GND0.3V to (V <sub>CC</sub> + 0.3V)
RF Input Power+10dBm
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )
(derate 3.1mW/°C above +70°C)247mW
Operating Temperature Range40°C to +85°C

Junction Temperature	+150°C
θJC	+115°C/W
θ_J_Α	
Storage Temperature Range	
Lead Temperature (soldering, 10s)	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**CAUTION!** ESD SENSITIVE DEVICE

Note: This part is not for automotive applications.

## DC ELECTRICAL CHARACTERISTICS

( $V_{CC}$  = 2.7V to 3.3V,  $T_A$  = -40°C to +85°C, ENA = 2.0V, no RF signal applied. Typical values are at  $V_{CC}$  = 2.85V,  $T_A$  = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
Supply Voltage	Vcc		2.7		3.3	V
Operating Supply Current	Icc			1.2	2.5	mA
Sleep Mode Supply Current		ENA = 0V		0.5	10	μA
ENA Logic-High Threshold	VIH		2			V
ENA Logic-Low Threshold	VIL				0.6	V
ENA Input Current		ENA = 2V	-2		+10	μA
		ENA = 0.6V	-2		+1	μΑ

### **AC ELECTRICAL CHARACTERISTICS**

(MAX2204 Evaluation Kit,  $V_{CC} = 2.85V$ ,  $T_A = -40^{\circ}$ C to  $+85^{\circ}$ C, ENA = 2.0V.  $f_{RF} = 450$ MHz to 2.5GHz. Typical values are at  $V_{CC} = 2.85V$ ,  $T_A = +25^{\circ}$ C, unless otherwise noted.) (Note 1)

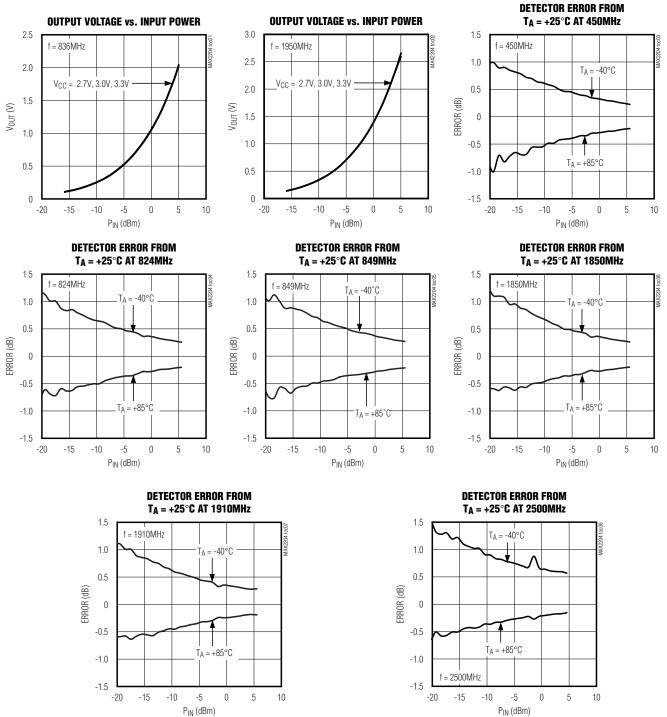
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
RF Input Frequency				450		2500	MHz
DE Input Loval for 2.0V		$T_A = +25^{\circ}C$ , RFIN at 83	36MHz	3.3	4.8	6.3	dBm
RF Input Level for 2.0V		$T_A = +25^{\circ}C$ , RFIN at 1880MHz		1.9	3.4	4.9	UDIII
Minimum Input Level		-16dBm to -15dBm change in P <sub>IN</sub> (836MHz to 2500MHz)		8	14		mV
Power Detector Accuracy Due to	V <sub>CC</sub> = 2.85V, 836MHz to 1880MHz	$P_{IN}$ for 2.0V output		±0.5	±1.1		
Temperature		T <sub>A</sub> = -40°C to +85°C (Note 2)	P <sub>IN</sub> for 0.1V output		±1.5	±4	dB
In Dand Variation		824MHz to 849MHz			0.1		dB
In-Band Variation		1850MHz to 1980MHz			0.2		uВ

**Note 1:** Specifications over  $T_A = -40^{\circ}$ C to +85°C are guaranteed by design. Production tests are performed at  $T_A = +25^{\circ}$ C. **Note 2:** Guaranteed by design and characterization.



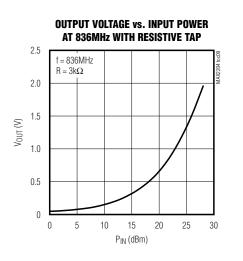
## **Typical Operating Characteristics**

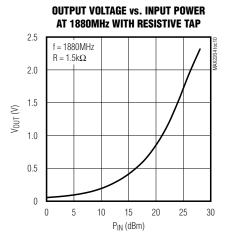
(MAX2204 Evaluation Kit, typical values are at  $V_{CC}$  = 2.85V, ENA = 2.0V,  $T_A$  = +25°C, modulation equals CW, unless otherwise noted.)

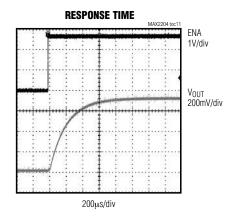


## **Typical Operating Characteristics (continued)**

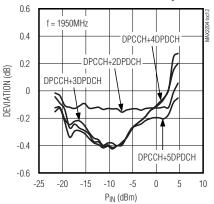
(MAX2204 Evaluation Kit, typical values are at  $V_{CC}$  = 2.85V, ENA = 2.0V,  $T_A$  = +25°C, modulation equals CW, unless otherwise noted.)



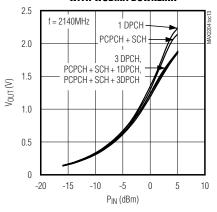




**DEVIATION FROM DPCCH+1DPDCH, 1950MHz** 



OUTPUT VOLTAGE vs. INPUT POWER WITH WCDMA DOWNLINK





### **Pin Description**

PIN	NAME	FUNCTION
1	Vcc	Power-Supply Pin. Bypass to GND with a capacitor as close as possible to the pin.
2 GND Ground Connection. Use multiple ground vias to connect the GND pin to the ground plane.		
3 RFIN RF Input. AC-couple with an external capacitor.		RF Input. AC-couple with an external capacitor.
4 ENA Enable Input. Drive low to turn the part off. Drive high or connect to V <sub>CC</sub> to turn the part or		Enable Input. Drive low to turn the part off. Drive high or connect to V <sub>CC</sub> to turn the part on.
5	OUT	Power Detector Output. Filter with a capacitor to GND.

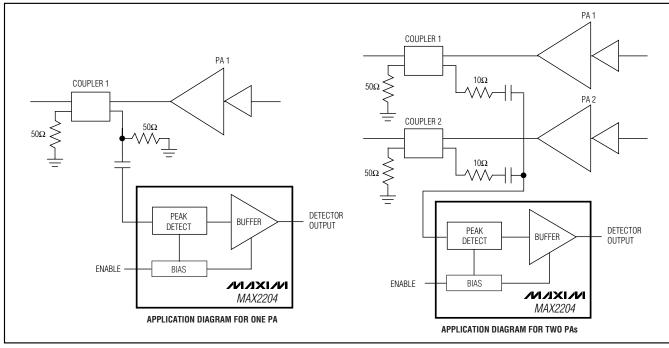


Figure 1. Typical Application Circuit

### **Detailed Description**

The MAX2204 RF power detector is designed to operate from 450MHz to 2.5GHz. The device accepts an RF signal at the input and outputs a highly repeatable voltage, which increases monotonically with increasing input power. See the *Typical Operating Characteristics*. The device is designed to compensate for temperature and process shifts, reducing the typical output variation to less than  $\pm$ 0.5dB at full input power and  $\pm$ 1.5dB at the lower power.

The MAX2204 features a detection range from -16dBm to +5dBm. High input impedance allows a for low-loss resistive tap if an isolator is used. The device uses external termination at the input so that the RF signal from several directional couplers can be connected to a single detector chip.

The MAX2204 features an enable input (ENA) that allows the device to be put in shutdown. For normal operation, drive ENA high or connect to  $V_{CC}$ . For device shutdown, drive ENA low.

The MAX2204 integrates an output series resistor of approximately  $100k\Omega$ . For output filtering, connect only a capacitor to ground at the output.

#### **Applications Information**

The MAX2204 uses external termination when using directional couplers. See Figure 1 for the typical application circuit. The output of the detector is typically connected to an ADC in cdma2000 or WCDMA power-control topology.

**MAX2204** 



FREQUENCY (GHz)	P <sub>IN</sub> = -16dBm		P <sub>IN</sub> = +5dBm		
	<b>REAL (</b> Ω <b>)</b>	IMAG (jΩ)	<b>REAL (</b> Ω <b>)</b>	IMAG (jΩ)	
0.4	109.3	-556.5	120.0	-563.3	
0.6	80.5	-369.0	91.0	-379.3	
0.8	73.4	-300.3	80.8	-310.7	
1.0	64.1	-260.2	75.6	-275.8	
1.2	65.8	-216.4	79.9	-231.3	
1.4	62.3	-194.9	64.4	-202.8	
1.6	48.9	-177.5	53.9	-192.3	
1.8	33.1	-157.4	39.9	-174.6	
2.0	21.8	-142.2	25.9	-158.3	
2.2	15.2	-131.2	18.3	-144.5	
2.4	10.6	-116.8	10.6	-131.9	
2.6	11.8	-99.8	10.6	-115.6	

#### Table 1. MAX2204 Input Impedance Over Frequency

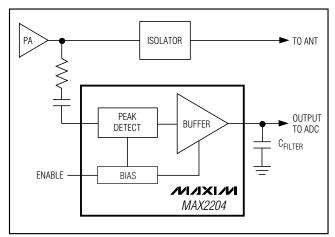


Figure 2. Typical Application Circuit Using Resistive Tapping from a Power Amplifier

The MAX2204 has high input impedance to allow for high-value resistive tapping from a power amplifier. This coupling method is the lowest cost and lowest power loss when used with an isolator. See Figure 2 for the typical application circuit.

The MAX2204 input impedance over frequency is listed in Table 1.

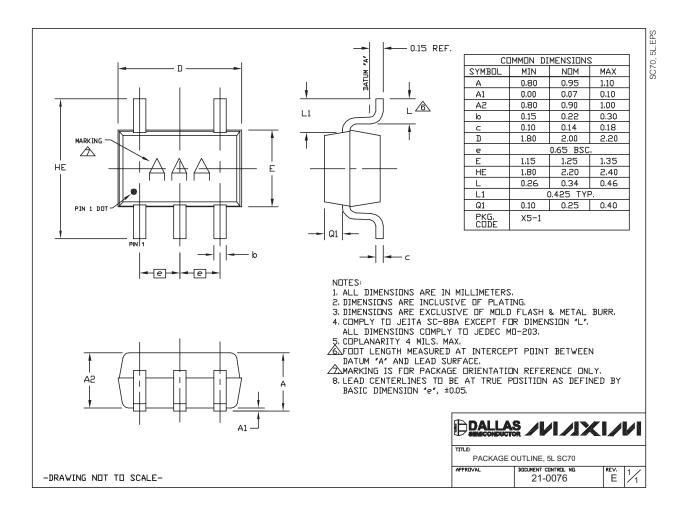
### Layout

The MAX2204 is not particularly sensitive to the layout, since it only needs 5dBm for maximum output voltage. However, there are two areas that need attention: the GND pin and the supply bypassing. The GND pin should be connected to the PCB ground with a GND via as close as possible, and the supply bypass capacitor should be close to the part.

**MAX2204** 

### **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <u>www.maxim-ic.com/packages</u>.)



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